

## FEATURES

- 25, 45 ns Read Access & R/W Cycle Time
- Unlimited Read/Write Endurance
- Directly replaces battery-backed SRAM modules such as Dallas/Maxim DS1230 AB
- Automatic Non-volatile STORE on Power Loss
- Non-Volatile STORE Under Hardware or Software Control
- Automatic RECALL to SRAM on Power Up
- Unlimited RECALL Cycles
- 1 Million STORE Cycles
- 100-Year Non-volatile Data Retention
- Single 5V  $\pm$  10% Power Supply
- Commercial and Industrial Temperatures
- 28-pin 600-mil PDIP Package (RoHS-Compliant)

## DESCRIPTION

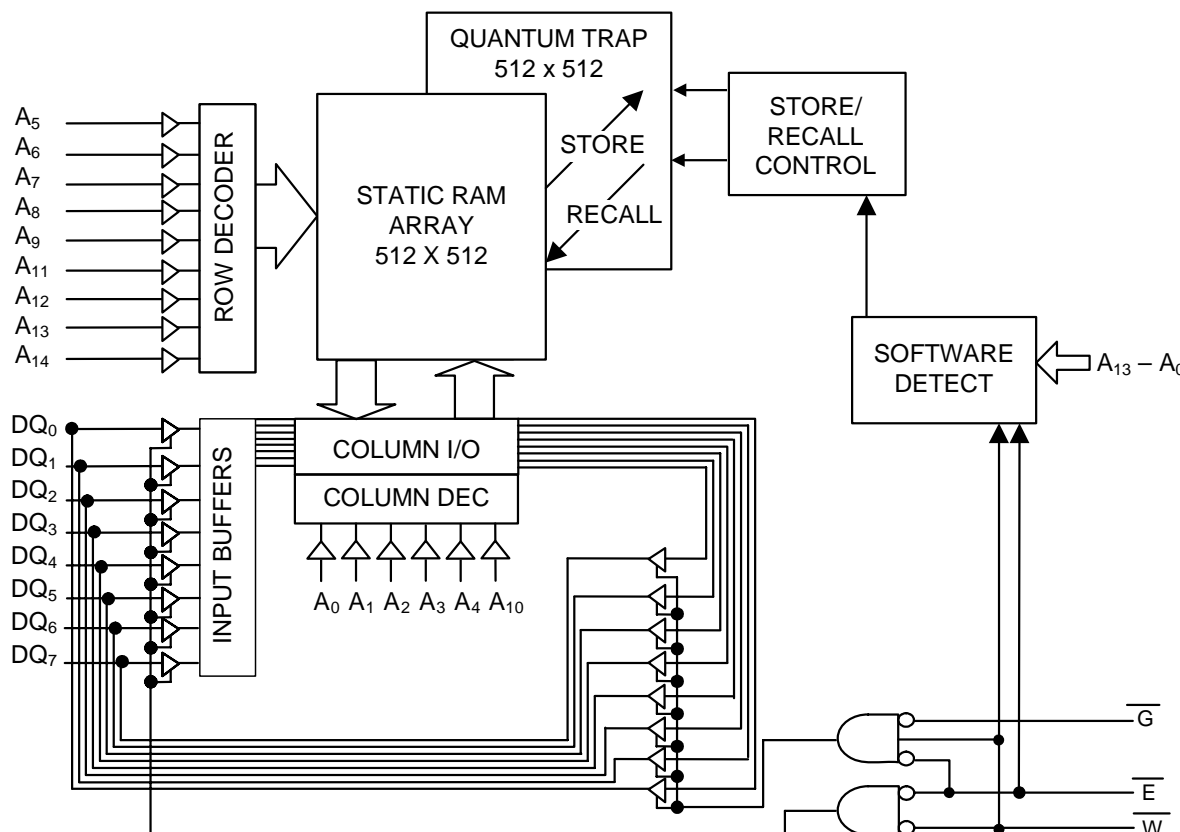
The Simtek STK16C88 is a 256Kb fast static RAM with a non-volatile Quantum Trap storage element included with each memory cell.

The SRAM provides the fast access & cycle times, ease of use and unlimited read & write endurance of a normal SRAM.

Data transfers automatically to the non-volatile storage cells when power loss is detected (the *STORE* operation). On power up, data is automatically restored to the SRAM (the *RECALL* operation). Both *STORE* and *RECALL* operations are also available under software control.

The Simtek nvSRAM is the first monolithic non-volatile memory to offer unlimited writes and reads. It is the highest performance, most reliable non-volatile memory available.

## BLOCK DIAGRAM



**PIN CONFIGURATIONS**

A14	1	28	VCC
A12	2	27	$\overline{W}$
A7	3	26	A13
A6	4	25	A8
A5	5	24	A9
A4	6	23	A11
A3	7	22	$\overline{G}$
A2	8	21	A10
A1	9	20	$\overline{E}$
A0	10	19	DQ7
DQ0	11	18	DQ6
DQ1	12	17	DQ5
DQ2	13	16	DQ4
VSS	14	15	DQ3

**28 Pin 600 mil PDIP****PIN CONFIGURATIONS**

Pin Name	I/O	Description
A <sub>14</sub> -A <sub>0</sub>	Input	Address: The 15 address inputs select one of 32,768 bytes in the nvSRAM array
DQ <sub>7</sub> -DQ <sub>0</sub>	I/O	Data: Bi-directional 8-bit data bus for accessing the nvSRAM
$\overline{E}$	Input	Chip Enable: The active low $\overline{E}$ input selects the device
$\overline{W}$	Input	Write Enable: The active low $\overline{W}$ enables data on the DQ pins to be written to the address location latched by the falling edge of $\overline{E}$
$\overline{G}$	Input	Output Enable: The active low $\overline{G}$ input enables the data output buffers during read cycles. De-asserting $\overline{G}$ high caused the DQ pins to tri-state.
V <sub>CC</sub>	Power Supply	Power: 5.0V, ±10%
V <sub>SS</sub>	Power Supply	Ground

## ABSOLUTE MAXIMUM RATINGS<sup>a</sup>

Voltage on Input Relative to Ground	−0.5V to 7.0V
Voltage on Input Relative to $V_{SS}$	−0.6V to ( $V_{CC} + 0.5V$ )
Voltage on $DQ_{0-7}$	−0.5V to ( $V_{CC} + 0.5V$ )
Temperature under Bias	−55°C to 125°C
Storage Temperature	−65°C to 150°C
Power Dissipation	1W
DC Output Current (1 output at a time, 1s duration)	15mA

Note a: Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## DC CHARACTERISTICS

( $V_{CC} = 5.0V \pm 10\%$ )

SYMBOL	PARAMETER	COMMERCIAL		INDUSTRIAL		UNITS	NOTES
		MIN	MAX	MIN	MAX		
$I_{CC1}^b$	Average $V_{CC}$ Current		97 70		100 70	mA mA	$t_{AVAV} = 25ns$ $t_{AVAV} = 45ns$
$I_{CC2}^c$	Average $V_{CC}$ Current during <i>STORE</i>		3		3	mA	All Inputs Don't Care, $V_{CC} = \max$
$I_{CC3}^b$	Average $V_{CC}$ Current at $t_{AVAV} = 200ns$ 5V, 25°C, Typical		10		10	mA	$\overline{W} \geq (V_{CC} - 0.2V)$ All Others Cycling, CMOS Levels
$I_{SB1}^d$	Average $V_{CC}$ Current (Standby, Cycling TTL Input Levels)		30 22		31 23	mA mA	$t_{AVAV} = 25ns, \overline{E} \geq V_{IH}$ $t_{AVAV} = 45ns, \overline{E} \geq V_{IH}$
$I_{SB2}^d$	$V_{CC}$ Standby Current (Standby, Stable CMOS Input Levels)		1.5		1.5	mA	$\overline{E} \geq (V_{CC} - 0.2V)$ All Others $V_{IN} \leq 0.2V$ or $\geq (V_{CC} - 0.2V)$
$I_{ILK}$	Input Leakage Current		$\pm 1$		$\pm 1$	$\mu A$	$V_{CC} = \max$ $V_{IN} = V_{SS}$ to $V_{CC}$
$I_{OLK}$	Off-State Output Leakage Current		$\pm 5$		$\pm 5$	$\mu A$	$V_{CC} = \max$ $V_{IN} = V_{SS}$ to $V_{CC}$ , $\overline{E}$ or $\overline{G} \geq V_{IH}$
$V_{IH}$	Input Logic “1” Voltage	2.2	$V_{CC} + .5$	2.2	$V_{CC} + .5$	V	All Inputs
$V_{IL}$	Input Logic “0” Voltage	$V_{SS} - .5$	0.8	$V_{SS} - .5$	0.8	V	All Inputs
$V_{OH}$	Output Logic “1” Voltage	2.4		2.4		V	$I_{OUT} = -4mA$
$V_{OL}$	Output Logic “0” Voltage		0.4		0.4	V	$I_{OUT} = 8mA$
$T_A$	Operating Temperature	0	70	−40	85	°C	

Note b:  $I_{CC1}$  and  $I_{CC3}$  are dependent on output loading and cycle rate. The specified values are obtained with outputs unloaded.

Note c:  $I_{CC2}$  and  $I_{CC4}$  are the average currents required for the duration of the respective *STORE* cycles ( $t_{STORE}$ ).

Note d:  $\overline{E} \geq V_{IH}$  will not produce standby current levels until any nonvolatile cycle in progress has timed out.

## AC TEST CONDITIONS

Input Pulse Levels	0V to 3V
Input Rise and Fall Times	$\leq 5ns$
Input and Output Timing Reference Levels	1.5V
Output Load	See Figure 1

## CAPACITANCE<sup>e</sup> ( $T_A = 25^\circ C, f = 1.0MHz$ )

SYMBOL	PARAMETER	MAX	UNITS	CONDITIONS
$C_{IN}$	Input Capacitance	5	pF	$\Delta V = 0$ to 3V
$C_{OUT}$	Output Capacitance	7	pF	$\Delta V = 0$ to 3V

Note e: These parameters are guaranteed but not tested.

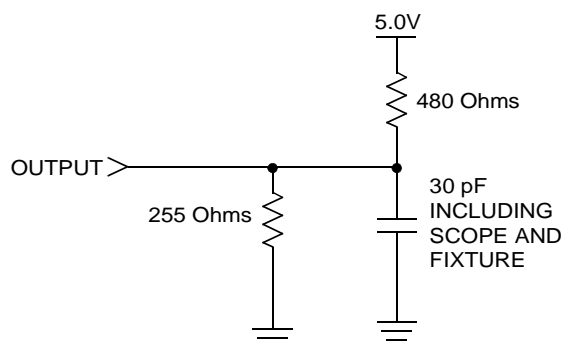


Figure 1: AC Output Loading

## SRAM READ CYCLES #1 & #2

( $V_{CC} = 5.0V \pm 10\%$ )

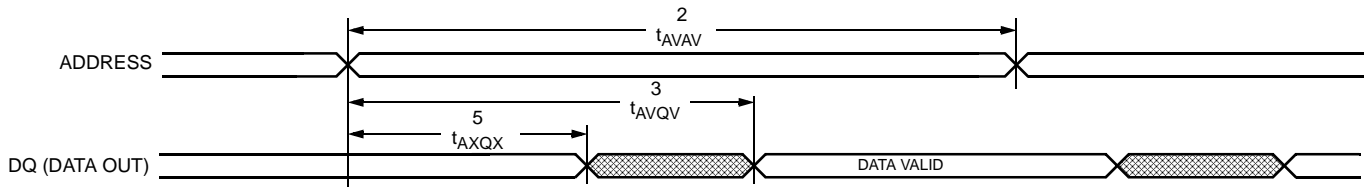
NO.	SYMBOLS		PARAMETER	STK16C88-25		STK16C88-45		UNITS
	#1, #2	Alt.		MIN	MAX	MIN	MAX	
1	$t_{ELQV}$	$t_{ACS}$	Chip Enable Access Time		25		45	ns
2	$t_{AVAV}^f$	$t_{RC}$	Read Cycle Time	25		45		ns
3	$t_{AVQV}^g$	$t_{AA}$	Address Access Time		25		45	ns
4	$t_{GLQV}$	$t_{OE}$	Output Enable to Data Valid		10		20	ns
5	$t_{AXQX}^g$	$t_{OH}$	Output Hold after Address Change	5		5		ns
6	$t_{ELQX}$	$t_{LZ}$	Chip Enable to Output Active	5		5		ns
7	$t_{EHQZ}^h$	$t_{HZ}$	Chip Disable to Output Inactive		10		15	ns
8	$t_{GLQX}$	$t_{OLZ}$	Output Enable to Output Active	0		0		ns
9	$t_{GHQZ}^h$	$t_{OHZ}$	Output Disable to Output Inactive		10		15	ns
10	$t_{ELICCH}^e$	$t_{PA}$	Chip Enable to Power Active	0		0		ns
11	$t_{EHICCL}^{d, e}$	$t_{PS}$	Chip Disable to Power Standby		25		45	ns

Note f:  $\overline{W}$  must be high during SRAM READ cycles and low during SRAM WRITE cycles.

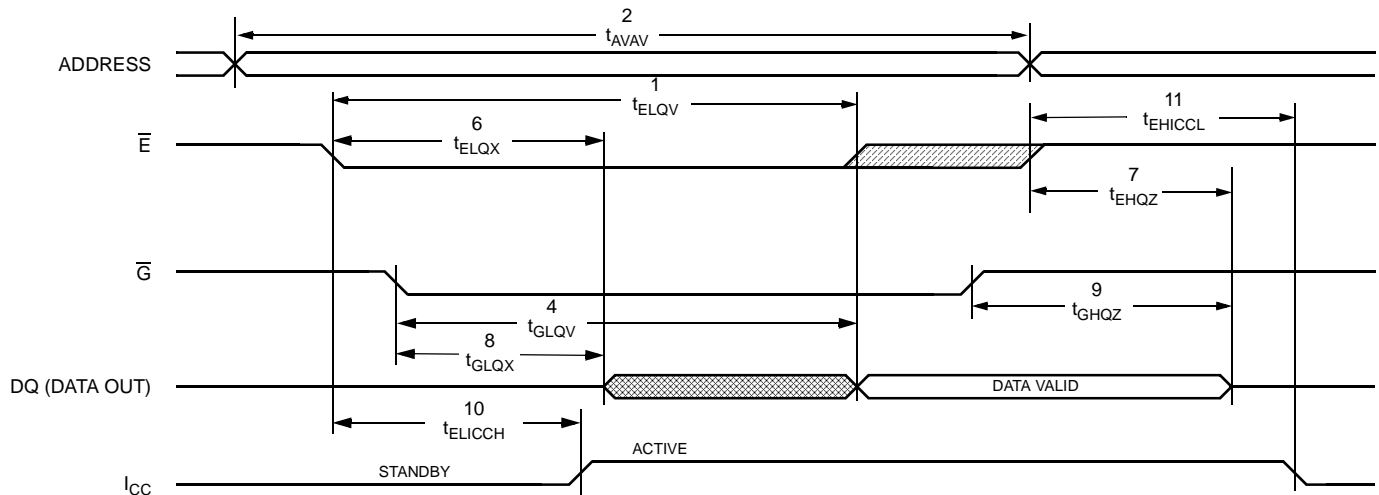
Note g: I/O state assumes  $\overline{E}$ ,  $\overline{G} \leq V_{IL}$  and  $\overline{W} \geq V_{IH}$ ; device is continuously selected.

Note h: Measured  $\pm 200mV$  from steady state output voltage.

### SRAM READ CYCLE #1: Address Controlled<sup>f, g</sup>



### SRAM READ CYCLE #2: $\overline{E}$ Controlled<sup>f</sup>

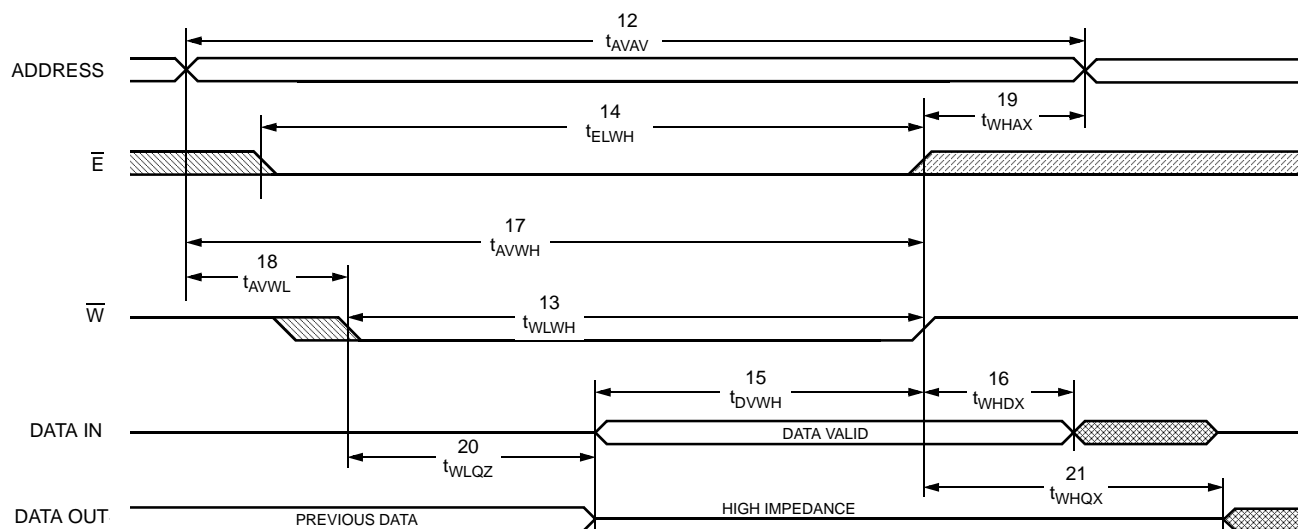
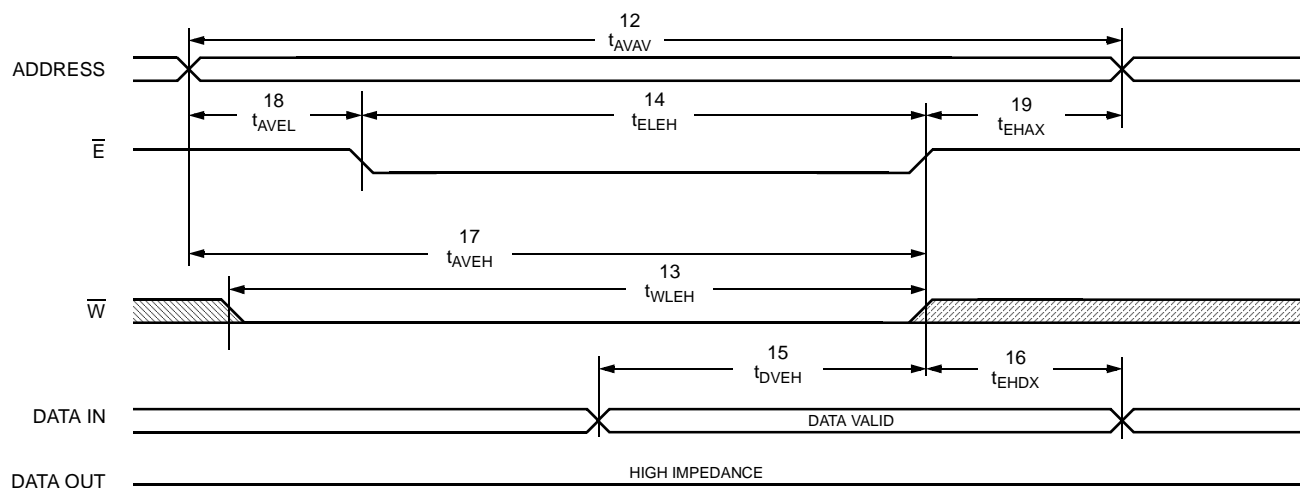


**SRAM WRITE CYCLES #1 & #2**
**(V<sub>CC</sub> = 5.0V ± 10%)**

NO.	SYMBOLS			PARAMETER	STK16C88-25		STK16C88-45		UNITS
	#1	#2	Alt.		MIN	MAX	MIN	MAX	
12	t <sub>AVAV</sub>	t <sub>AVAV</sub>	t <sub>WC</sub>	Write Cycle Time	25		45		ns
13	t <sub>WLWH</sub>	t <sub>WLEH</sub>	t <sub>WP</sub>	Write Pulse Width	20		30		ns
14	t <sub>ELWH</sub>	t <sub>ELEH</sub>	t <sub>CW</sub>	Chip Enable to End of Write	20		30		ns
15	t <sub>DVWH</sub>	t <sub>DVEH</sub>	t <sub>DW</sub>	Data Set-up to End of Write	10		15		ns
16	t <sub>WHDX</sub>	t <sub>EHDH</sub>	t <sub>DH</sub>	Data Hold after End of Write	0		0		ns
17	t <sub>AVWH</sub>	t <sub>AVEH</sub>	t <sub>AW</sub>	Address Set-up to End of Write	20		30		ns
18	t <sub>AVWL</sub>	t <sub>AVEL</sub>	t <sub>AS</sub>	Address Set-up to Start of Write	0		0		ns
19	t <sub>WHAX</sub>	t <sub>EHAX</sub>	t <sub>WR</sub>	Address Hold after End of Write	0		0		ns
20	t <sub>WLQZ</sub> <sup>h, i</sup>		t <sub>WZ</sub>	Write Enable to Output Disable		10		15	ns
21	t <sub>WHQX</sub>		t <sub>OW</sub>	Output Active after End of Write	5		5		ns

Note i: If  $\bar{W}$  is low when  $\bar{E}$  goes low, the outputs remain in the high-impedance state.

Note j:  $\bar{E}$  or  $\bar{W}$  must be  $\geq V_{IH}$  during address transitions.

**SRAM WRITE CYCLE #1:  $\bar{W}$  Controlled<sup>j</sup>**

**SRAM WRITE CYCLE #2:  $\bar{E}$  Controlled<sup>j</sup>**


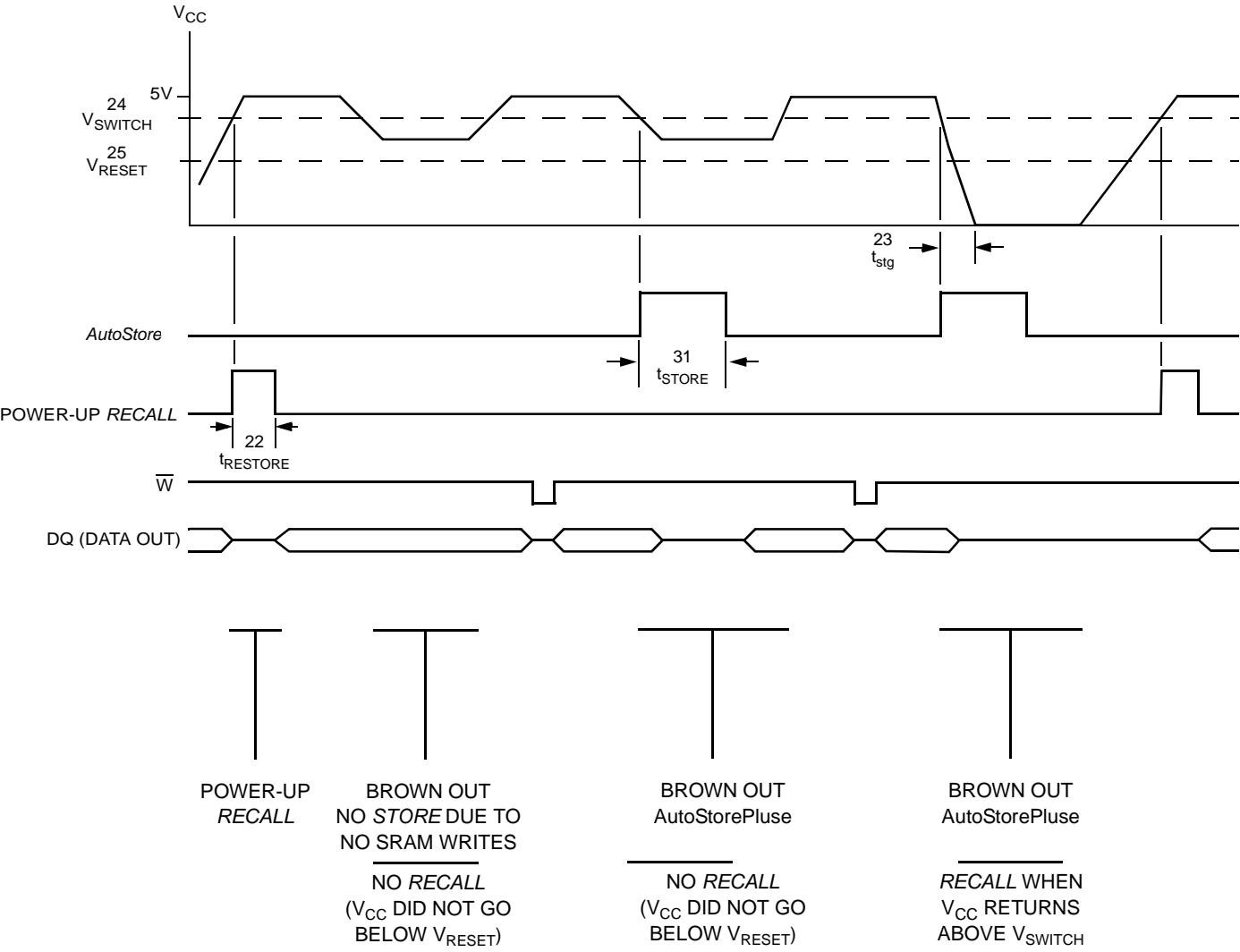
AutoStorePluse/POWER-UP RECALL

(V<sub>CC</sub> = 5.0V ± 10%)

NO.	SYMBOLS	PARAMETER	STK16C88		UNITS	NOTES
	Standard		MIN	MAX		
22	t <sub>RESTORE</sub>	Power-up <i>RECALL</i> Duration		550	μs	k
23	t <sub>stg</sub>	Power-down <i>AutoStore</i> <sup>TM</sup> Slew Time to Ground	500		ns	e, g
24	V <sub>SWITCH</sub>	Low Voltage Trigger Level	4.0	4.5	V	
25	V <sub>RESET</sub>	Low Voltage Reset Level		3.6	V	

Note k: t<sub>RESTORE</sub> starts from the time V<sub>CC</sub> rises above V<sub>SWITCH</sub>.

AutoStorePluse/POWER-UP RECALL



## SOFTWARE STORE/RECALL MODE SELECTION

$\bar{E}$	$\bar{W}$	A <sub>13</sub> - A <sub>0</sub> (hex)	MODE	I/O	NOTES
L	H	0E38	Read SRAM	Output Data	l, m
		31C7	Read SRAM	Output Data	
		03E0	Read SRAM	Output Data	
		3C1F	Read SRAM	Output Data	
		303F	Read SRAM	Output Data	
		0FC0	Nonvolatile <i>STORE</i>	Output High Z	
L	H	0E38	Read SRAM	Output Data	l, m
		31C7	Read SRAM	Output Data	
		03E0	Read SRAM	Output Data	
		3C1F	Read SRAM	Output Data	
		303F	Read SRAM	Output Data	
		0C63	Nonvolatile <i>RECALL</i>	Output High Z	

Note l: The six consecutive addresses must be in the order listed.  $\bar{W}$  must be high during all six consecutive cycles to enable a nonvolatile cycle.

Note m: While there are 15 addresses on the STK16C88, only the lower 14 are used to control software modes.

## SOFTWARE STORE/RECALL CYCLE<sup>n, o</sup>

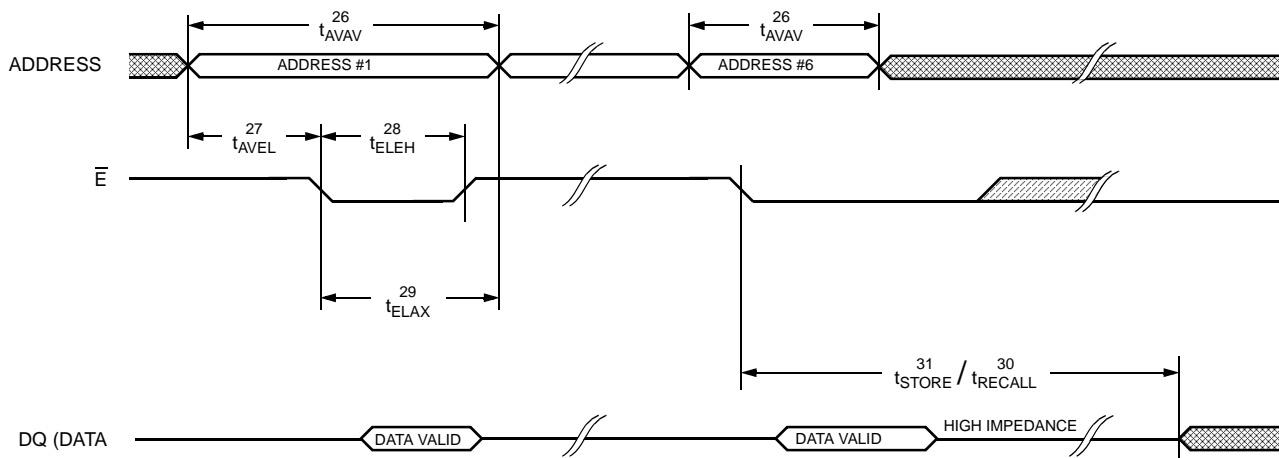
(V<sub>CC</sub> = 5.0V ± 10%)

NO.	SYMBOLS	PARAMETER	STK16C88-25		STK16C88-45		UNITS
			MIN	MAX	MIN	MAX	
26	t <sub>AVAV</sub>	<i>STORE/RECALL</i> Initiation Cycle Time	25		45		ns
27	t <sub>AVEL</sub> <sup>n</sup>	Address Set-up Time	0		0		ns
28	t <sub>ELEH</sub> <sup>n</sup>	Clock Pulse Width	20		30		ns
29	t <sub>ELAX</sub> <sup>g, n</sup>	Address Hold Time	20		20		ns
30	t <sub>RECALL</sub>	<i>RECALL</i> Cycle Duration		20		20	μs
31	t <sub>STORE</sub>	<i>STORE</i> Cycle Duration		10		10	ms

Note n: The software sequence is clocked with  $\bar{E}$  controlled reads.

Note o: The six consecutive addresses must be in the order listed in the Software *STORE/RECALL* Mode Selection Table: (0E38, 31C7, 03E0, 3C1F, 303F, 0FC0) for a *STORE* cycle or (0E38, 31C7, 03E0, 3C1F, 303F, 0C63) for a *RECALL* cycle.  $\bar{W}$  must be high during all six consecutive cycles.

## SOFTWARE STORE/RECALL CYCLE: $\bar{E}$ Controlled<sup>o</sup>



## **nvSRAM OPERATION**

The AutoStore+ STK16C88 is a fast 32K x 8 SRAM that does not lose its data on power-down. The data is preserved in integral QuantumTrap non-volatile storage elements when power is lost. Automatic STORE on power-down and automatic RECALL on power-up guarantee data integrity without the use of batteries.

### **NOISE CONSIDERATIONS**

Note that the STK16C88 is a high-speed memory and so must have a high-frequency bypass capacitor of approximately 0.1 $\mu$ F connected between  $V_{CC}$  and  $V_{SS}$ , using leads and traces that are as short as possible. As with all high-speed CMOS ICs, normal careful routing of power, ground and signals will help prevent noise problems.

### **SRAM READ**

The STK16C88 performs a READ cycle whenever  $\overline{E}$  and  $\overline{G}$  are low and  $\overline{W}$  is high. The address specified on pins  $A_{0-14}$  determines which of the 32,768 data bytes will be accessed. When the READ is initiated by an address transition, the outputs will be valid after a delay of  $t_{AVQV}$  (READ cycle #1). If the READ is initiated by  $\overline{E}$  or  $\overline{G}$ , the outputs will be valid at  $t_{ELQV}$  or at  $t_{GLQV}$ , whichever is later (READ cycle #2). The data outputs will repeatedly respond to address changes within the  $t_{AVQV}$  access time without the need for transitions on any control input pins, and will remain valid until another address change or until  $\overline{E}$  or  $\overline{G}$  is brought high.

### **SRAM WRITE**

A WRITE cycle is performed whenever  $\overline{E}$  and  $\overline{W}$  are low. The address inputs must be stable prior to entering the WRITE cycle and must remain stable until either  $\overline{E}$  or  $\overline{W}$  goes high at the end of the cycle. The data on the common I/O pins  $DQ_{0-7}$  will be written into the memory if it is valid  $t_{DVWH}$  before the end of a  $\overline{W}$  controlled WRITE or  $t_{DVEH}$  before the end of an  $\overline{E}$  controlled WRITE.

It is recommended that  $\overline{G}$  be kept high during the entire WRITE cycle to avoid data bus contention on the common I/O lines. If  $\overline{G}$  is left low, internal circuitry will turn off the output buffers  $t_{WLQZ}$  after  $\overline{W}$  goes low.

### **AutoStore+ OPERATION**

The STK16C88's automatic STORE on power-down is completely transparent to the system. The STORE initiation takes less than 500ns when power is lost ( $V_{CC} < V_{SWITCH}$ ) at which point the part depends only on its internal capacitor for STORE completion.

If the power supply drops faster than 20  $\mu$ s/volt before  $V_{CC}$  reaches  $V_{switch}$ , then a 2.2 ohm resistor should be inserted between  $V_{CC}$  and the system supply to avoid a momentary excess of current between  $V_{CC}$  and internal capacitor.

In order to prevent unneeded STORE operations, automatic STOREs will be ignored unless at least one WRITE operation has taken place since the most recent STORE or RECALL cycle. Software initiated STORE cycles are performed regardless of whether or not a WRITE operation has taken place.

### **POWER-UP RECALL**

During power up, or after any low-power condition ( $V_{CC} < V_{RESET}$ ), an internal RECALL request will be latched. When  $V_{CC}$  once again exceeds the sense voltage of  $V_{SWITCH}$ , a RECALL cycle will automatically be initiated and will take  $t_{RESTORE}$  to complete.

If the STK16C88 is in a WRITE state at the end of power-up RECALL, the SRAM data will be corrupted. To help avoid this situation, a 10k $\Omega$  resistor should be connected either between  $\overline{W}$  and system  $V_{CC}$  or between  $\overline{E}$  and system  $V_{CC}$ .

### **SOFTWARE NONVOLATILE STORE**

The STK16C88 software STORE cycle is initiated by executing sequential READ cycles from six specific address locations. During the STORE cycle, previous non-volatile data is erased and then the SRAM contents are written to the non-volatile storage elements. Once a STORE cycle is initiated, further inputs and outputs are disabled until the cycle is completed.

Because a sequence of READs from specific addresses is used for STORE initiation, it is important that no other READ or WRITE accesses intervene in the sequence or the sequence will be aborted and no STORE or RECALL will take place.

To initiate the software STORE cycle, the following READ sequence must be performed:



1. Read address	0E38 (hex)	Valid READ
2. Read address	31C7 (hex)	Valid READ
3. Read address	03E0 (hex)	Valid READ
4. Read address	3C1F (hex)	Valid READ
5. Read address	303F (hex)	Valid READ
6. Read address	0FC0 (hex)	Initiate <i>STORE</i> cycle

The software sequence must be clocked with  $\overline{E}$  controlled READS.

Once the sixth address in the sequence has been entered, the *STORE* cycle will commence and the chip will be disabled. It is important that READ cycles and not WRITE cycles be used in the sequence, although it is not necessary that  $\overline{G}$  be low for the sequence to be valid. After the  $t_{STORE}$  cycle time has been fulfilled, the SRAM will again be activated for READ and WRITE operation.

## SOFTWARE NONVOLATILE *RECALL*

A software *RECALL* cycle is initiated with a sequence of READ operations in a manner similar to the software *STORE* initiation. To initiate the *RECALL* cycle, the following sequence of READ operations must be performed:

1. Read address	0E38 (hex)	Valid READ
2. Read address	31C7 (hex)	Valid READ
3. Read address	03E0 (hex)	Valid READ
4. Read address	3C1F (hex)	Valid READ
5. Read address	303F (hex)	Valid READ
6. Read address	0C63 (hex)	Initiate <i>RECALL</i> cycle

Internally, *RECALL* is a two-step procedure. First, the SRAM data is cleared, and second, the nonvolatile information is transferred into the SRAM cells. After the  $t_{RECALL}$  cycle time the SRAM will once again be ready for READ and WRITE operations. The

*RECALL* operation in no way alters the data in the non-volatile storage elements. The nonvolatile data can be recalled an unlimited number of times.

## HARDWARE PROTECT

The STK16C88 offers hardware protection against inadvertent *STORE* operation and SRAM WRITES during low-voltage conditions. When  $V_{CC} < V_{SWITCH}$ , all software *STORE* operations and SRAM WRITES are inhibited.

## LOW AVERAGE ACTIVE POWER

The STK16C88 draws significantly less current when it is cycled at times longer than 50ns. Figure 2 shows the relationship between  $I_{CC}$  and READ cycle time. Worst-case current consumption is shown for both CMOS and TTL input levels (commercial temperature range,  $V_{CC}=5.5V$ , 100% duty cycle on chip enable). Figure 3 shows the same relationship for WRITE cycles. If the chip enable duty cycle is less than 100%, only standby current is drawn when the chip is disabled. The overall average current drawn by the STK16C88 depends on the following items: 1) CMOS vs. TTL input levels; 2) the duty cycle of chip enable; 3) the overall cycle rate for accesses; 4) the ratio of READs to WRITES; 5) the operating temperature; 6) the  $V_{CC}$  level; and 7) I/O loading.

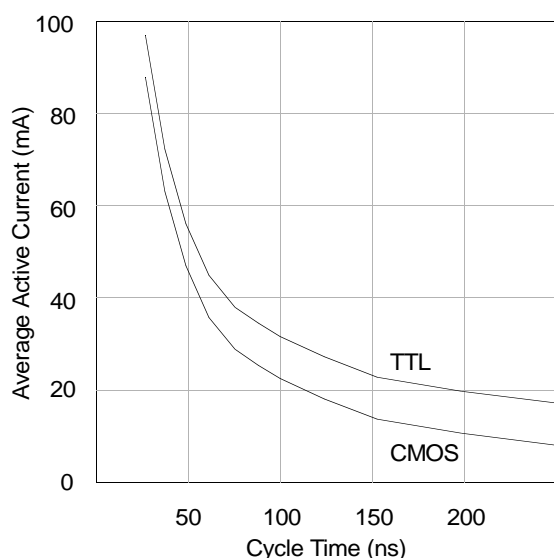


Figure 2:  $I_{CC}$  (max) Reads

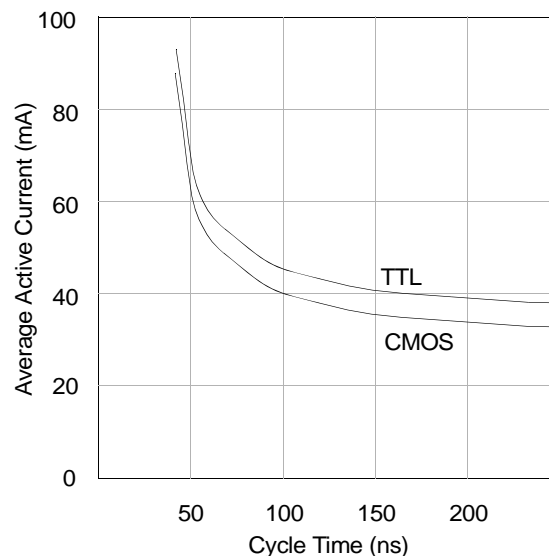


Figure 3:  $I_{CC}$  (max) Writes

## ORDERING INFORMATION

**STK16C88 - W F 45 I**

### Temperature Range

Blank = Commercial (0 to 70°C)

I = Industrial (−40 to 85°C)

### Access Time

25 = 25ns

45 = 45ns

### Lead Finish

F = 100% Sn (Matte Tin)

### Package

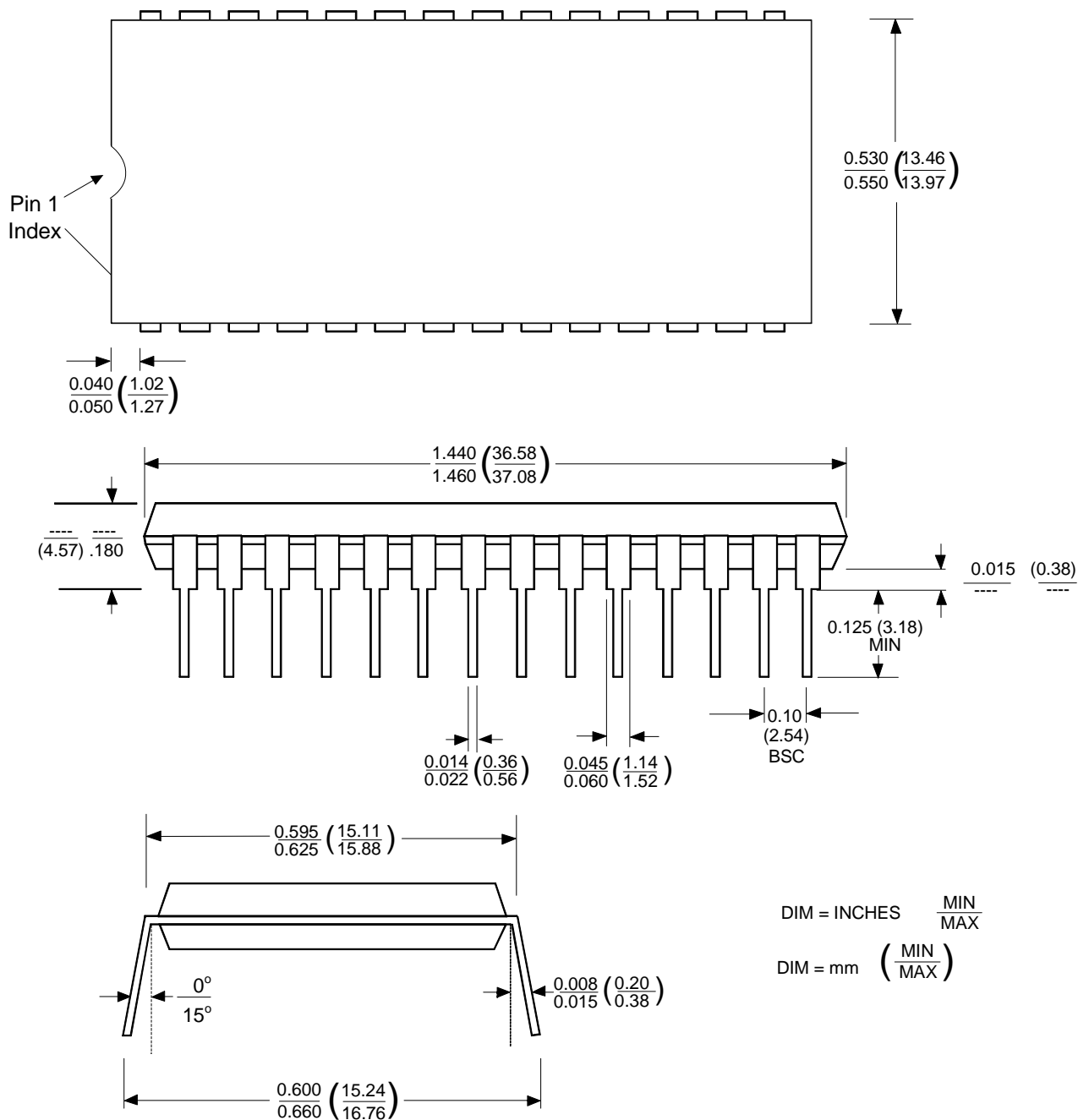
W = Plastic 28-pin 600 mil DIP

## ORDERING CODES

Part Number	Description	Temperature
STK16C88-WF25	5V 32Kx8 AutoStore+ nvSRAM PDIP28-600	Commercial
STK16C88-WF45	5V 32Kx8 AutoStore+ nvSRAM PDIP28-600	Commercial
STK16C88-WF25I	5V 32Kx8 AutoStore+ nvSRAM PDIP28-600	Industrial
STK16C88-WF45I	5V 32Kx8 AutoStore+ nvSRAM PDIP28-600	Industrial

# PACKAGE DRAWING

## 28 Pin 600 mil PDIP



## Document Revision History

Revision	Date	Summary
0.0	December 2002	
0.1	September 2003	Added lead-free lead finish
0.2	March 2006	Removed 35ns speed Grade, Removed Leaded lead finish
0.3	February 2007	Add fast power-down slew rate information Add Product Ordering Code Listing Add Package Drawings Reformat Entire Document

SIMTEK STK16C88 Datasheet, February 2007

Copyright 2007, Simtek Corporation. All rights reserved.

This datasheet may only be printed for the expressed use of Simtek Customers. No part of the datasheet may be reproduced in any other form or means without the express written permission from Simtek Corporation. The information contained in this publication is believed to be accurate, but changes may be made without notice. Simtek does not assume responsibility for, or grant or imply any warranty, including MERCHANTABILITY or FITNESS FOR A PARTICULAR PURPOSE regarding this information, the product or its use. Nothing herein constitutes a license, grant or transfer of any rights to any Simtek patent, copyright, trademark, or other proprietary right.